

SPECIFICATIONS

At $\rm T_{_{A}}\!=\!+25^{\circ}C$ and $\rm V_{_{S}}\!=\!\pm15V$ unless otherwise specified.

			NA120C0	3	INA120BG, BP		INA120AP				
PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	MIN	ТҮР	МАХ	UNITS
GAIN Range of Gain Gain Equation Gain Error	G = 1 G = 10 G = 100	1	+ (2R _F /R 0.01 0.05 0.1	1000 _g) 0.05 0.1 0.2	1 1	+ (2R _F /R 0.01 0.05 0.1	1000 3) 0.05 0.2 0.3	1 1	+ (2R _F /R 0.02 0.1 0.2	1000 3) 0.1 0.2 0.5	V/V V/V % %
Gain Temp Coefficient	G = 1000 G = 1 G = 10 G = 100 G = 1000		0.3 4 4 6 22	0.5 10 10 30 50		0.3 4 4 6 22	1 20 20 40 50		0.5 6 8 10 40	1 20 40 60 100	% ppm/°C ppm/°C ppm/°C ppm/°C
Nonlinearity	G = 1 G = 10 G = 100 G = 1000		0.001 0.002 0.004 0.008	0.005 0.005 0.01 0.05		0.001 0.002 0.004 0.008	0.01 0.01 0.02 0.1		0.001 0.002 0.004 0.008	0.01 0.01 0.02 0.1	% of FS % of FS % of FS % of FS
OFFSET VOLTAGE Initial Offset			. ,	(25+ 600/G)	-	. ,	(100+ 1000/G)	-		(200+ 2000/G)	
vs Temperature vs Power Supply	$V_s = \pm 6V$ to $\pm 18V$	(1 + 20/G)	.25 + 10/0 (10 + 150			(1 + 20/G) (20 + 250/		(2 + 20/G) 1 + 20/G)		μV/°C /G) μV/V
INPUT BIAS CURRENT Initial Bias Current vs Temperature Initial Offset Current vs Temperature Impedance: Differential Common-Mode			±7 ±0.2 ±5 ±0.2 10 ¹⁰ 3 10 ¹⁰ 3	±20 ±10		±7 ±0.2 ±5 ±0.2 10 ¹⁰ 3 10 ¹⁰ 3	±20 ±20		±20 ±0.2 ±10 ±0.2 10 ¹⁰ 3 10 ¹⁰ 3	±50 ±50	nA nA/°C nA nA/°C Ω pF Ω pF
INPUT VOLTAGE RANGE Range, Linear Response CMRR (DC, 1kΩ Source Imbalance) G = 1 G = 10 G = 100 G = 1000	±10 80 96 106 106	±12.5 90 106 110 110		±10 74 90 106 106	±12.5 90 106 110 110		±10 70 86 100 100	±12.5 85 95 105 105		V dB dB dB dB
$\label{eq:second} \begin{array}{l} \textbf{NOISE} \\ \textbf{Input Voltage Noise} \\ f_{\text{B}} = 0.1\text{Hz to 10\text{Hz}} \\ \textbf{Density; } f = 10\text{Hz} \\ f = 100\text{Hz} \\ f = 1000\text{Hz} \\ \textbf{Input Current Noise} \\ f_{\text{B}} = 0.1\text{Hz to 10\text{Hz}} \\ \textbf{Density; } f = 10\text{Hz} \\ f = 1\text{Hz} \\ \textbf{Output Voltage Noise} \\ f_{\text{B}} = 0.1\text{Hz to 10\text{Hz}} \\ \textbf{Input Voltage Noise} \\ f_{\text{B}} = 0.1\text{Hz to 10\text{Hz}} \\ \end{array}$	G = 1000 G = 1000		0.7 14 11 10 50 1.8 0.4 8			0.7 14 11 10 50 1.8 0.4 8			0.7 14 11 10 50 1.8 0.4 8		µV p-p nV/\Hz nV/\Hz nV/\Hz nV/\Hz pAp-p pA/\Hz pA/\Hz μVp-p
DYNAMIC RESPONSE Small Signal Bandwidth (-3dB) Slew Rate Settling Time to 0.01% Full Power Bandwidth, G < 200 Overload Recovery	$\begin{array}{c} G = 1 \\ G = 10 \\ G = 100 \\ G = 1000 \\ \end{array} \\ \begin{array}{c} G = 1 \\ G = 10 \\ G = 100 \\ G = 1000 \\ \end{array} \\ \begin{array}{c} G = 100 \\ G = 1000 \\ \end{array} \\ \begin{array}{c} V_{0} = \pm 10V, \ R_{L} = 2k\Omega \\ 50\% \ Overdrive \end{array}$	0.4	2 200 2 0.6 24 30 50 200 9 2		0.4	2 200 20 2 0.6 24 30 50 200 9 2		0.4	2 200 2 0.6 24 30 50 200 9 2		MHz kHz kHz kHz μs μs μs μs kHz μs
$\label{eq:output} \begin{array}{l} \textbf{OUTPUT}\\ \text{Voltage, } \textbf{R}_{\text{L}} = 2k\Omega\\ \text{Current}\\ \text{Short-Circuit Current}\\ \text{Capacitive Load, Stable Operation} \end{array}$	Over Temperature Over Temperature	±10.5 5	±12.8 15 24 4000		±10.5 5	±12.8 15 24 4000		±10.5 5	±12.8 15 24 4000		V mA mA pF
POWER SUPPLY Rated Voltage Voltage Range Supply Current	V _o = 0V	±6	±15 ±2.7	±18 ±4	±6	±15 ±2.7	±18 ±4	±6	±15 ±2.7	±18 ±4	V V mA
TEMPERATURE RANGE Specification Operation BP,AP Operation CG,BG Storage		-25 -55 -65		+85 +125 +150	-25 -40 -55 -65 See Absol	ute Maxir	+85 +85 +125 +150 num Table	-25 -40 -65		+85 +85 +150	ဂံ ဂံ ဂံ ဂံ



PIN CONFIGURATION



ABSOLUTE MAXIMUM RATINGS

Supply Voltage	±18V
Input Voltage Range	(V+) +2 to (V–) –2V
Differential Input Voltage	Total V _s +4V
Operating Temperature	-
Ceramic G Package	65°C to +150°C
Plastic P Package	40°C to +125°C
Storage Temperature	
Ceramic G Package	65°C to +150°C
Plastic P Package	40°C to +125°C
Junction Temperature	
Ceramic G Package	+175°C
Plastic P Package	+125°C
Lead Temperature (soldering, 10s)	+300°C

PACKAGE INFORMATION(1)

MODEL	PACKAGE	PACKAGE DRAWING NUMBER
INA120AP	18-Pin Plastic DIP	218
INA120BP	18-Pin Plastic DIP	218
INA120BG	18-Pin Ceramic DIP	158
INA120CG	18-Pin Ceramic DIP	158

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

ORDERING INFORMATION

MODEL	PACKAGE	TEMPERATURE RANGE
INA120AP INA120BP INA120BG INA120CG	18-Pin Plastic DIP 18-Pin Plastic DIP 18-Pin Ceramic DIP 18-Pin Ceramic DIP	-25°C to +85°C -25°C to +85°C -25°C to +85°C -25°C to +85°C -25°C to +85°C

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INA120

TYPICAL PERFORMANCE CURVES

 T_{A} = +25°C, V_{S} = ±15V unless otherwise noted.













TYPICAL PERFORMANCE CURVES (CONT)

 $T_{_{A}}$ = +25°C, $V_{_{S}}$ = $\pm 15V$ unless otherwise noted.





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CURRENT LIMIT vs TEMPERATURE 35 30 Current Limit (mA) Output Op Amp 25 20 15 -75 -50 -25 0 +25 +50 +75 +100 +125 Ambient Temperature (°C)











Time (20µs/ Division)



TYPICAL PERFORMANCE CURVES (CONT)

 $T_A = +25^{\circ}C$, $V_S = \pm 15V$ unless otherwise noted.





APPLICATION INFORMATION

Figure 1 shows the basic connections required for operation of the INA120. Applications with noisy or high impedance power supply lines may require decoupling capacitors close to the device pins as shown. The differential input voltage is applied to pins 16 and 3.

The output is referred to the output common reference terminal, pin 18. This terminal must have a low-impedance connection to ground. A resistance of 1Ω or greater in series with the common terminal could degrade common-mode rejection beyond the specified value.

SETTING THE GAIN

Gains of 1, 10, 100 or 1000 can be configured by interconnecting the gain-set pins as shown in the table of Figure 1. These pin-strapped gains provide best gain accuracy and drift because they are determined by the ratios of accurately trimmed and matched on-chip resistors.

Digital gain control can be achieved using an analog multiplexer as shown in Figure 2. Since the switches are in series with the high impedance gain-sense connections, pins 4 and 15, their series resistance does not significantly affect gain error or drift. Gain error at G = 1 is slightly higher than with direct pin connections shown in Figure 1. The gain is selected with a two-bit address, A_0 and A_1 . The Multiplexer Enable control is directly connected to V+ since a logic "low" on this line would cause the input amplifiers to run open-loop.

Other gains may be set by connecting an external resistor, $R_{_{\rm G}}$, as shown in Figure 3a. Gain accuracy using an external gain-setting resistor is a function of $R_{_{\rm G}}$ and the internal 20k Ω resistors. The internal resistors are typically within $\pm 0.2\%$ of nominal value and their drift under $\pm 80 \text{ppm/}^\circ\text{C}$. Inaccuracy and drift of $R_{_{\rm G}}$ will contribute additional gain error and drift.

Figure 3b shows an external gain-setting resistor connected in parallel with internal resistors. By forming a portion of the

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effective R_{g} with internal resistors, gain accuracy and drift can be somewhat improved.

Connections available on the INA120 allow all input stage gain-setting resistors to be provided externally. A custom precision resistor network could be connected to provide the highest accuracy and lowest gain drift for non-standard gains. Impedance of this external network should be made close to that of the internal network for best performance.

OFFSET TRIMMING

Many applications require no external offset voltage trimming. Figure 4 shows optional circuits for trimming offset voltage. Since the INA120 has two amplification stages, the offset voltage is comprised of two components—the input stage offset and output stage offset.

The input stage offset is equal to the combined offset of op amps A_1 and A_2 . This input stage offset dominates at high gain. When used in gains of 100 to 1000, it is often sufficient to adjust the input stage offset with a potentiometer connected to pins 6 and 7 as shown. Connect both inputs to ground and adjust for 0V at the output, pin 1. Do not use pins 6 and 7 to trim offset voltage at G = 1 or to correct for offset in devices following the INA120 since this can cause excessive offset voltage drift.

At G = 1, offset is dominated by the output stage. Output stage offset can be trimmed by applying a correction voltage at the output reference terminal, pin 18. Low impedance must be maintained at this node to preserve the high CMR of the INA120. This is achieved by buffering the trim voltage with an op amp as shown.

At intermediate gains it may be necessary to provide both input stage and output stage offset adjustments. Again, ground both inputs. Connect a jumper between pins 9 and 11 (temporarily connects the INA120 in high gain) and adjust R_1 for 0V at the output, pin 1. Then disconnect the jumper and adjust the output offset control for 0V output.



FIGURE 1. Basic Connection.



FIGURE 2. Digital Gain Control.







FIGURE 3. External Gain-Setting Resistors.

INPUT BIAS CURRENT RETURN PATH

The input impedance of the INA120 is extremely high approximately $10^{10}\Omega$. This does not mean, however, that no current flows in the input terminals. The input bias current of the INA120 is typically ±10nA (it can be either polarity). High input impedance means that this input bias current changes very little with varying input voltage.

Input circuitry must provide a path for this input bias current if the INA120 is to function. Figure 5 shows various provisions for an input bias current path. Without an appropriate current path, the inputs will float to a potential which



exceeds the common-mode range of the INA120 and the input amplifiers will saturate.

INPUT PROTECTION

The inputs of the INA120 are protected for input voltages up to 2V beyond the power supply voltages. If the input can exceed these conditions, input clamp diodes should be provided as shown in Figure 6. R_s may not be required if the input cannot supply more than 100mA. If the input can supply larger currents, choose R_s according to the maximum source voltage, limiting current to under 100mA.



FIGURE 4. Offset Adjustment Circuits.



FIGURE 5. Providing an Input Bias Current Path.



FIGURE 6. Input Protection Circuit.



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					$10.0V \qquad 6 \qquad REF102_{(2)} \qquad V+ $
ISA TYPE	MATERIAL	SEEBECK COEFFICIENT (µV/°C)	R ₂ (R ₃ = 100Ω)	R ₄ (R ₅ + R ₆ =100Ω)	$ \begin{array}{c c} & & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ $
E	Chromel Constantan	58.5	3.48k	56.2k	R ₆ 100Ω
J	Iron Constantan	50.2	4.12k	64.9k	Zero Adj NOTES: (1) −2.1mV/°C at 200µA.
К	Chromel Alumel	39.4	5.23k	80.6k	(2) R ₇ provides down-scale burn-out
Т	Copper Constantan	38.0	5.49k	84.5k	

FIGURE 7. Thermocouple Amplifier With Cold Junction Compensation.



FIGURE 8. Guard Drive Circuit.



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